

DOCKET NO. 01-C-084 (STMI01-01084)

PATENT

Customer No. 30425

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re application of : Harry Michael Siegel, et al.
U.S. Serial No. : 10/066,245
Filed : January 31, 2002
For : METHOD FOR USING A PRE-FORMED FILM IN A TRANSFER
MOLDING PROCESS FOR AN INTEGRATED CIRCUIT (AS
AMENDED)
Group No. : 1732
Examiner : Angela Y. Ortiz

MAIL STOP AF

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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Sir:

The undersigned hereby certifies that the following documents:

1. Amendment and Response Under 37 C.F.R. §1.116; and
2. Postcard Receipt

relating to the above application, were deposited as "First Class Mail" with the United States Postal Service, addressed to MAIL STOP AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 20, 2004.

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Sirs:

AMENDMENT AND RESPONSE UNDER 37 C.F.R. § 1.116

In response to the Office Action dated October 20, 2004, please amend the above-identified patent application as follows.